

●Student's Application Procedures

Please read the following carefully and make sure to follow each step.

★Application Period : October 16 to October 30 (JST)

★Step 1: Prepare the Required Documents (Before the application period begins)

Prepare the required documents for the online application.

Japanese

https://www.kansai-u.ac.jp/Kokusai/future/application_jp/

English

https://www.kansai-u.ac.jp/Kokusai/future/application_en/

Notes:

- Please check the **sample documents** from the website before filling them out.
- Only documents **issued within the last 3 months** are considered valid.

★Step 2: Complete the Online Application

Please complete the online application during the application period.

Online Application Portal : KU Gate

KU Gate URL: Will be sent to the students directly on October 16 (JST).

Deadline: October 30 (JST)

【Future Procedures】

① After submitting the application

Kansai University will review the content. In case of any missing documents or the documents need to be revised, students are expected to receive an email from KU Gate.

② Filling out the information for COE application (**November 10 to November 15, JST**)

Students must fill in the necessary information for COE application on KU Gate portal. The notification email will be sent to the students on November 10.

*Our outsourcing company, Daiichi Sogo Group, in charge of COE application, will screen the information and send an inquiry through KU Gate in case they have any questions.

③ Letter of Acceptance & COE application (In December)

After completing the internal procedures at Kansai University, the university will issue Letter of Acceptance and proceed with the COE application to Immigration Services Agency, Japan.

④ Sending of Welcome Pack (with e-COE) (In February)

After Kansai University officially determines students' acceptance, as soon as the e-COE is ready, a Welcome Pack will be sent via email from Kansai University to the applicants directly.

Inquiry : Kansai University Division of International Affairs

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